

BB182LX

VHF variable capacitance diode Rev. 01 — 29 January 2009

Product data sheet

Product profile

1.1 General description

The BB182LX is a planar technology variable capacitance diode in a SOD882T ultra small leadless plastic SMD package. The excellent matching performance is achieved by gliding matching and a Direct Matching Assembly (DMA) procedure.

1.2 Features

- High linearity
- Excellent matching to 2 % DMA
- Ultra small leadless SMD package
- $C_{d(28V)}$:2.7 pF; $C_{d(1V)}$ to $C_{d(28V)}$ ratio: 22
- Low series resistance

1.3 Applications

- Voltage Controlled Oscillators (VCO)
- Electronic tuning in VHF television tuners, Band A up to 160 MHz

Pinning information 2.

Table 1. **Pinning**

	3	
Pin	Description	Simplified outline Graphic symbol
1	cathode	[1]
2	anode	1 2
		Transparent sym008 top view

^[1] The marking bar indicates the cathode.

Ordering information 3.

Table 2. **Ordering information**

Type number	Package				
	Name	Description	Version		
BB182LX	-	leadless ultra small plastic package; 2 terminals; body $1.0 \times 0.6 \times 0.4$ mm	SOD882T		



4. Marking

Table 3. Marking codes

Type number	Marking code
BB182LX	L7

5. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{R}	reverse voltage		-	32	V
I _F	forward current		-	20	mA
T _{stg}	storage temperature		-55	+150	°C
Tj	junction temperature		-55	+125	°C

6. Characteristics

Table 5. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I _R	reverse current	see Figure 3				
		V _R = 30 V	-	-	10	nA
		$V_R = 30 \text{ V}; T_j = 85 ^{\circ}\text{C}$	-	-	200	nΑ
r _s	diode series resistance	$f = 100 \text{ MHz}$ at $C_d = 30 \text{ pF}$; see Figure 2	-	1.0	-	Ω
C _d	diode capacitance	f = 1 MHz; see <u>Figure 1</u> and <u>Figure 4</u>				
		$V_R = 1 V$	52	-	62	pF
		V _R = 28 V	2.48	2.7	2.89	pF
$C_{d(1V)}/C_{d(2V)}$	diode capacitance ratio (1 V to 2 V)	f = 1 MHz	-	1.31	-	
C _{d(1V)} /C _{d(28V)}	diode capacitance ratio (1 V to 28 V)	f = 1 MHz	20.6	22	-	
C _{d(25V)} /C _{d(28V)}	diode capacitance ratio (25 V to 28 V)	f = 1 MHz	-	1.05	-	
$\Delta C_d/C_d$	diode capacitance matching	$V_R = 1 \text{ V to } 28 \text{ V; in sequence of } 5 \text{ diodes (gliding)}$	-	-	2	%

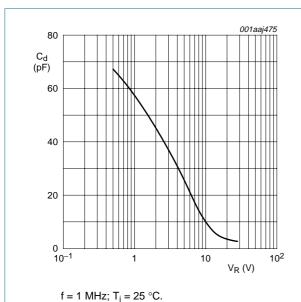


Fig 1. Diode capacitance as a function of reverse voltage; typical values

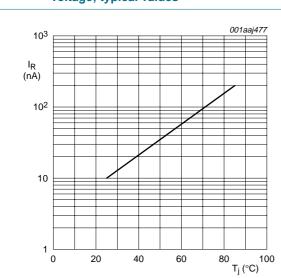


Fig 3. Reverse current as a function of junction temperature; maximum values

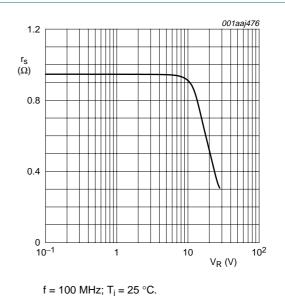
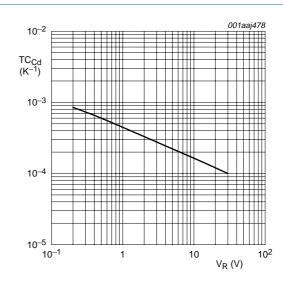


Fig 2. Diode serial resistance as a function of reverse voltage; typical values



 $T_i = 0$ °C to 85 °C.

Fig 4. Temperature coefficient of diode capacitance as a function of reverse voltage; typical values

7. Package outline

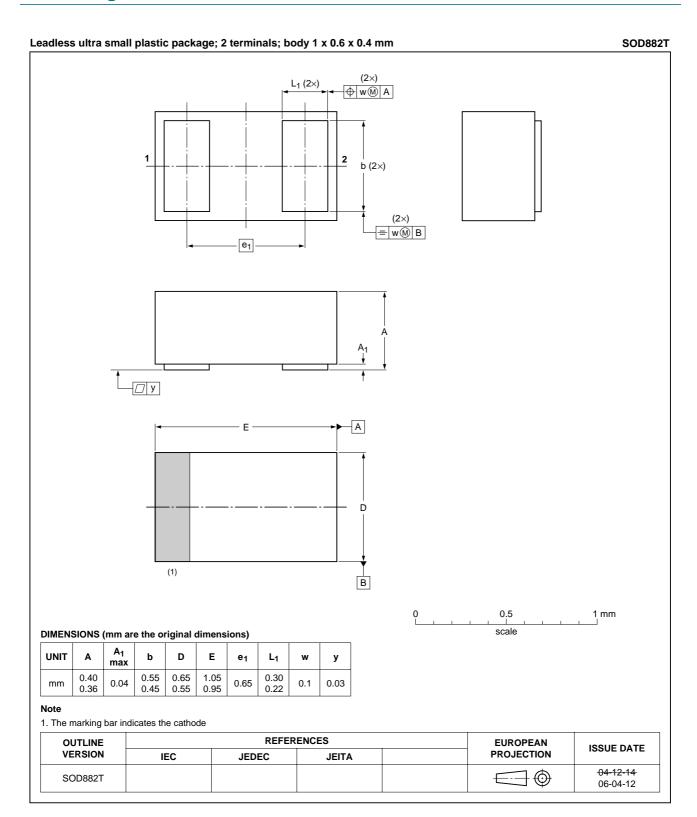


Fig 5. Package outline SOD882T

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8. Abbreviations

Table 6. Abbreviations

Acronym	Description
SMD	Surface Mounted Device
VHF	Very High Frequency

9. Revision history

Table 7. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BB182LX_1	20090129	Product data sheet	-	-

10. Legal information

10.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions"
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